

# 1A, 200V-1000V Surface Mount Rectifiers

#### **FEATURES**

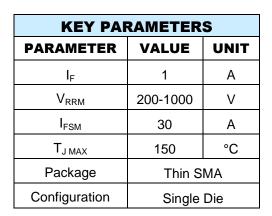
- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- Freewheeling application
- Switching mode converters and inverters, computer and telecommunication.

#### **MECHANICAL DATA**

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: As marked
- Weight: 0.029 g (approximately)











Thin SMA

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)								
PARAMETER		SYMBOL	S1DAL	S1GAL	S1JAL	S1KAL	S1MAL	UNIT
Marking code on the device			S1DAL	S1GAL	S1JAL	S1KAL	S1MAL	
Repetitive peak reverse voltage		$V_{RRM}$	200	400	600	800	1000	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	280	420	560	700	V
Forward current		I <sub>F</sub>	1				Α	
Surge peak forward current, single half sine-	8.3ms at T <sub>A</sub> = 25°C	I			30			Α
wave superimposed on rated load per diode	1.0ms at T <sub>A</sub> = 25°C	I <sub>FSM</sub>	100				А	
Junction temperature		TJ	-55 to +150				°C	
Storage temperature		T <sub>STG</sub>	-55 to +150			°C		



# S1DAL - S1MAL Taiwan Semiconductor

THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	29	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	82	°C/W	
Junction-to-case thermal resistance	$R_{\Theta JC}$	30	°C/W	

**Thermal Performance Note:** Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
	$I_F = 0.5A, T_J = 25^{\circ}C$		0.90	-	V
Forward voltage (1)	I <sub>F</sub> = 1A, T <sub>J</sub> = 25°C	\/	0.96	1.10	V
Forward voltage	$I_F = 0.5A, T_J = 125^{\circ}C$	V <sub>F</sub>	0.78	-	V
	I <sub>F</sub> = 1A, T <sub>J</sub> = 125°C		0.85	0.98	V
Reverse current @ rated V <sub>R</sub> (2)	T <sub>J</sub> = 25°C	_	-	1	μΑ
Reverse current @ rated V <sub>R</sub>	T <sub>J</sub> = 125°C	- I <sub>R</sub>	-	50	μΑ
Junction capacitance	1 MHz, V <sub>R</sub> =4.0V	CJ	8	-	pF

#### Notes:

- (1) Pulse test with PW=0.3 ms
- (2) Pulse test with PW=30 ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S1xAL M3G	Thin SMA	3,500 / 7" reel		
S1xAL M2G	Thin SMA	14,000 / 13" reel		

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#### Notes:

(1) "x" defines voltage from 200V(S1DAL) to 1000V(S1MAL)



#### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig.1 Forward Current Derating Curve

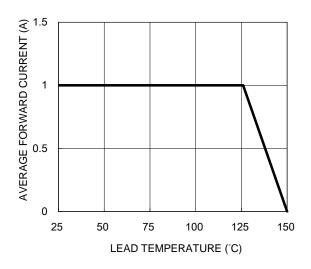


Fig.3 Typical Reverse Characteristics

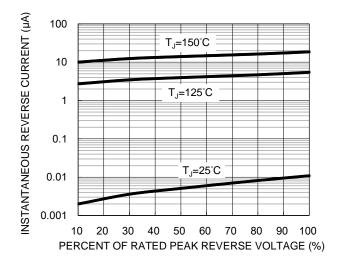


Fig.2 Typical Junction Capacitance

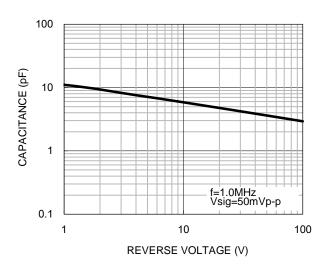


Fig.4 Typical Forward Characteristics

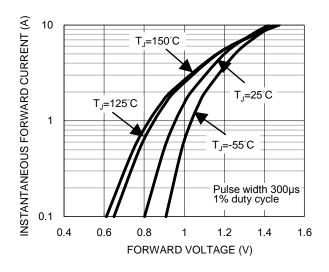
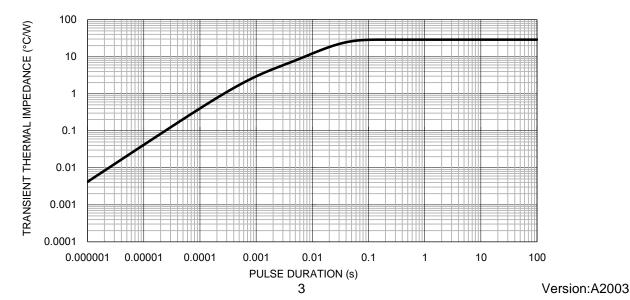


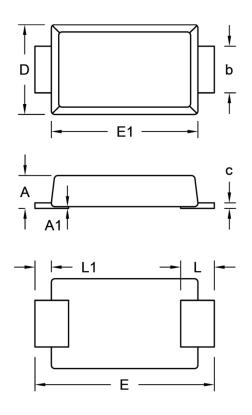
Fig.5 Typical Transient Thermal Impedance





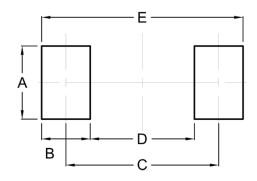
## **PACKAGE OUTLINE DIMENSIONS**

Thin SMA



DIM. Unit		(mm)	Unit (	(inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	0.90	1.00	0.035	0.039
A1	0.00	0.10	0.000	0.004
b	1.25	1.45	0.049	0.057
С	0.10	0.22	0.004	0.009
D	2.50	2.70	0.098	0.106
E	5.05	5.35	0.199	0.211
E1	4.15	4.35	0.163	0.171
L	0.75	1.20	0.030	0.047
L1	0.30	0.60	0.012	0.024

# **SUGGESTED PAD LAYOUT**



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

### **MARKING DIAGRAM**



P/N = Marking Code ΥW = Date Code = Factory Code



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